

# **Beryllium CCOS Grinding Phase I SBIR Summary**

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# Tinsley Aspheric Fabrication Process Four Core Technologies

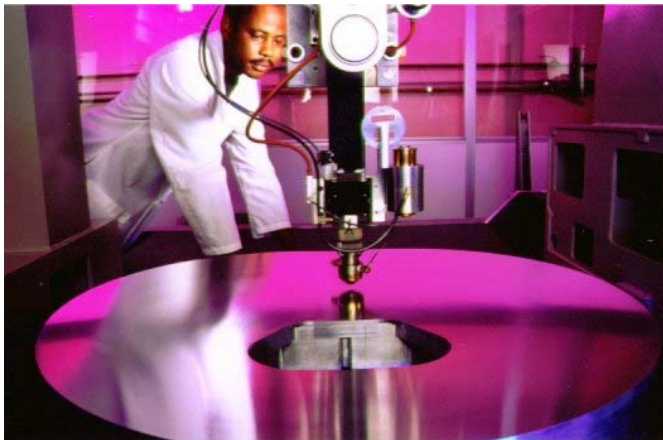


Precision Machining

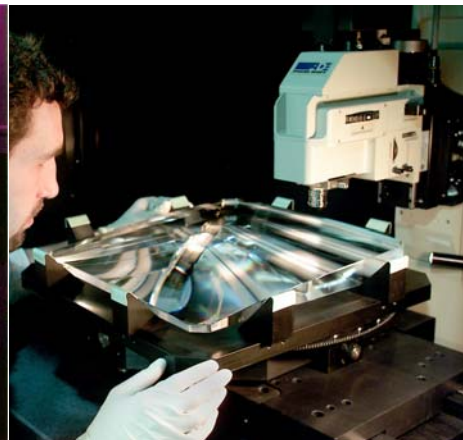


Surfacing

CCOS



Profilometry

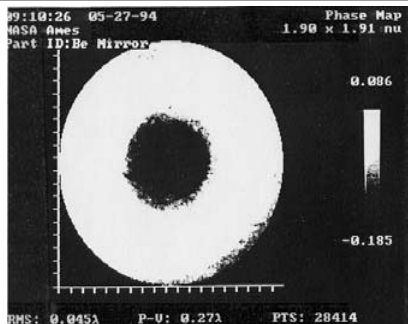


Microscopy & Phase Measuring Interferometry



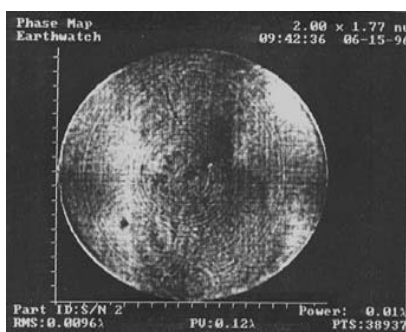
Metrology

# Tinsley CCOS Processes Demonstrated on Numerous Bare Beryllium Flight Mirrors



**NASA Ames Demo Mirror**

- 0.5 meter diameter
- 28 nm RMS



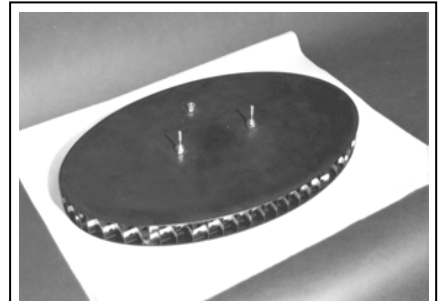
**Earthwatch**

- 0.45 x 0.3 meters
- 6 nm RMS



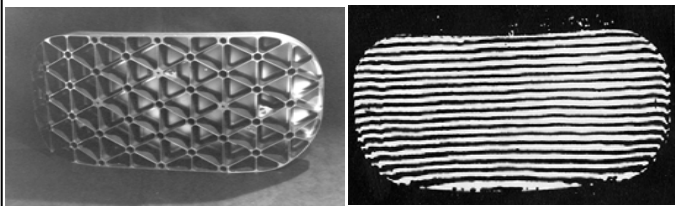
**SMTS**

- 0.25 meter diameter
- 12 nm RMS



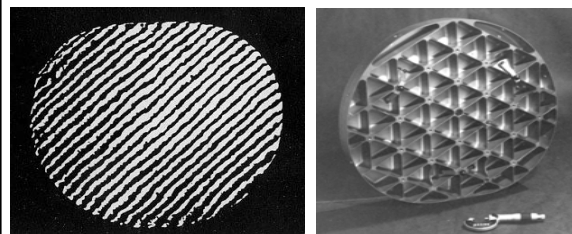
**TIR**

- 17 nm RMS 0.45 x 0.3 m
- Figured to < 5 mm of edge



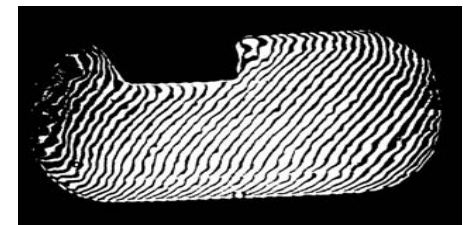
**GSTS (M3)**

- 0.75 x 0.37 meters
- 39 nm RMS
- Figured to < 5 mm of edge



**GSTS (M1)**

- ~0.5 meter diameter
- 15 nm RMS
- Figured to < 5 mm of edge

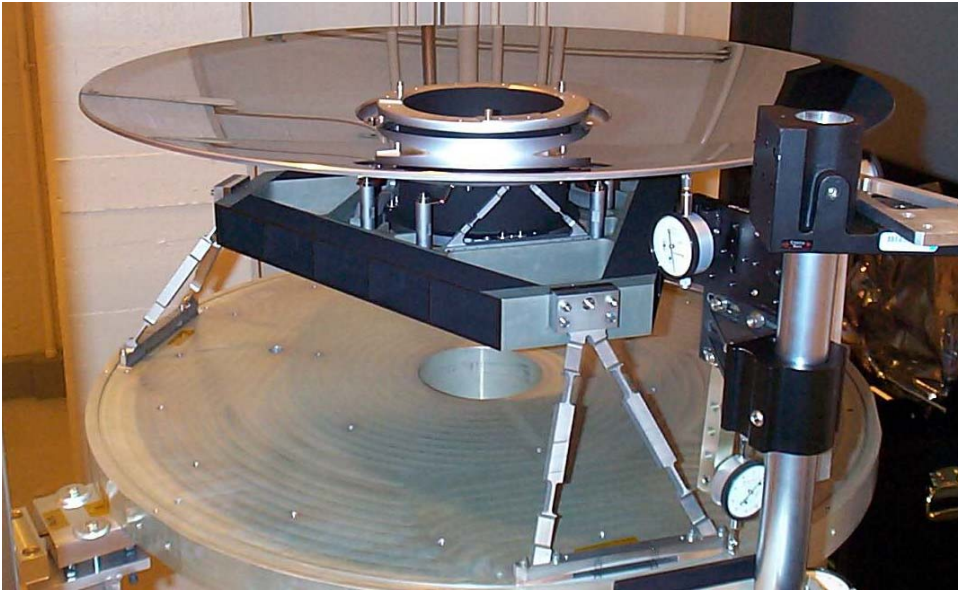


**FEWS**

- 80 nm RMS
- Figured to < 7 mm of edge

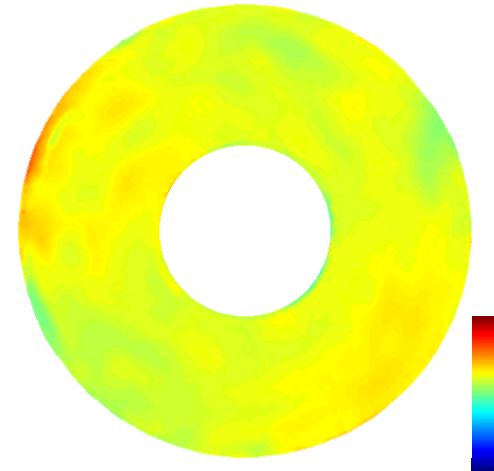
- Tinsley has demonstrated the ability to successfully finish bare beryllium optics on a number programs
- CCOS process suitable for flats, spheres, and aspheres

# Tinsley Beryllium Mirror Experience: SIRTF

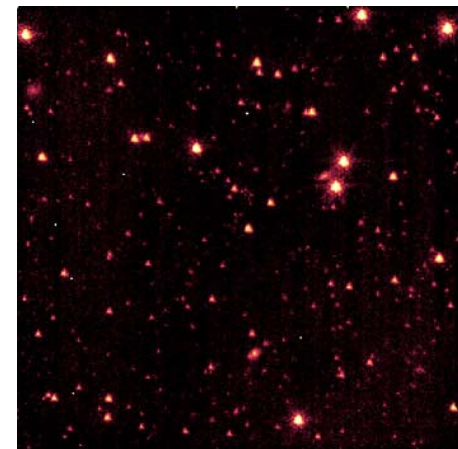


## SIRTF Primary Mirror

- 85-cm diameter
- I-70 Beryllium
- F/12 On axis hyperbola
- Double arch back design
- August 2003 Launch



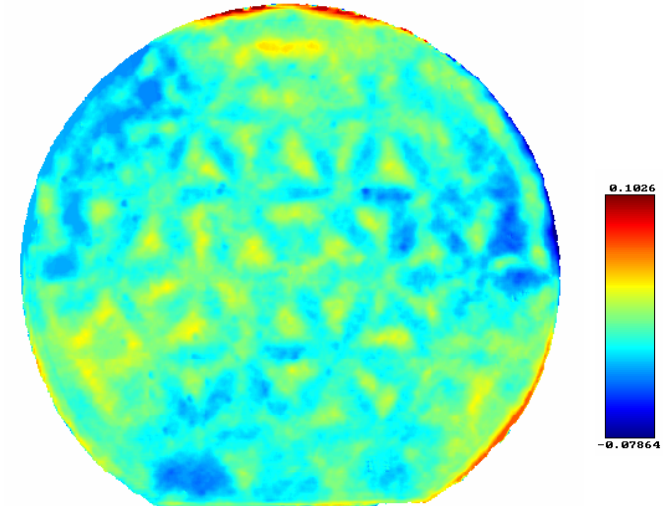
Cryo null figured for operation at 20 K  
• 67 nm rms surface figure



IRAC image through SIRTF telescope



# Tinsley Beryllium Mirror Experience: SBMD (Sub-scale Beryllium Mirror Demonstrator)



	<u>Key Specs</u>	<u>Test Results</u>
• Areal Density	< 11kg/m <sup>2</sup>	< 9.8kg/m <sup>2</sup>
• RMS figure (@20K)	25nm	9.1nm
• RMS Mid-freq (1-10cm)	12nm	7nm avg
• RMS surface roughness	4nm	4nm avg
• Operating temperature	20K	20K

**Test using IPI interferometer  
After cryo-null figuring Mirror  
Mounted at 20K**

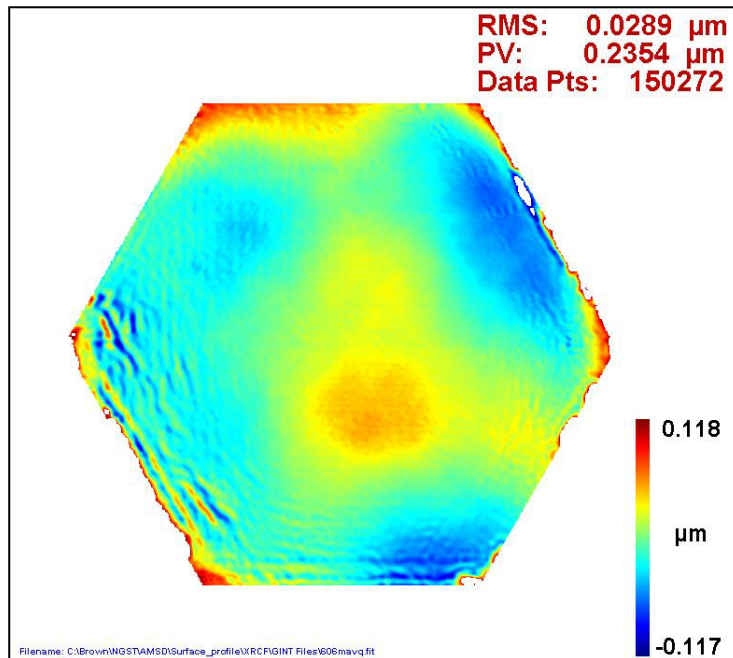
- Full CA Error: 9.5nm rms
- Mid-freq error : 7nm rms

- 0.5 meter diameter pathfinder for JWST
- Spherical lightweighted O-30 Beryllium substrate
- SBMD Cryo null figured to <10 nm RMS at 20 Kelvin

# Tinsley Beryllium Mirror Experience: AMSD (Advanced Mirror System Demonstrator)

## AMSD Key Parameters

- 1.2 meter bare Be aspheric mirror
- Off axis parabolic segment
- Ultra lightweight ( $9.8 \text{ Kg/m}^2$ ) O-30 substrate
- 29 nm rms figure accuracy demonstrated
- Mirror to be cryo null figured (20K)
- $\text{ROC} = 10,013\text{mm} \pm 1\text{mm}$



**AMSD Demonstrated to 29 nm RMS**



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## SBIR Objectives

- CCOS of Bare Beryllium Aspheric Optics
  - NASA Contract #NAS8-03036
  - TPOC: Dr. Phil Stahl, NASA/MSFC
- CCOS grinding and polishing of bare beryllium has been successfully demonstrated by Tinsley for a number of space-based telescope applications
  - SBMD, AMSD, SIRTF, FEWS, GSTS
- Grinding of bare beryllium is made difficult by the hardness and brittleness associated with beryllium
- Electrolytic In-Process Dressing has been applied successfully to metal surface grinding
  - In-situ tool dressing improves grinding efficiency
- ***SBIR activity conducted to apply similar in-situ tool dressing techniques to improve the material removal rate and uniformity associated with the CCOS grinding of beryllium***
  - ***Potential Process Improvements: (1) improved grind material removal rates; and (2) improved uniformity of grind rate over time***



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## Review of Phase I Activities/Issues

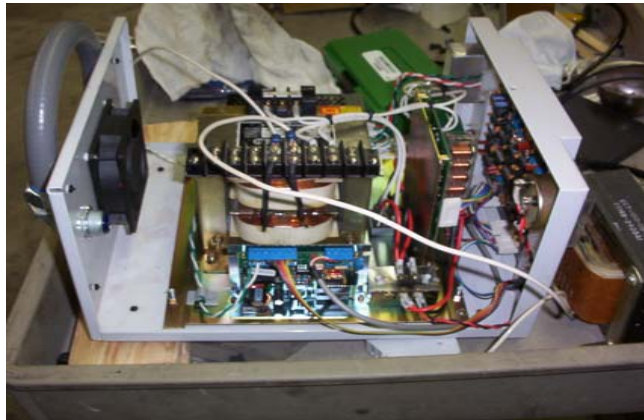
- **Selection of baseline tool dressing approach**
  - Electrolytic In-Situ Dressing versus EDM based approach
  - EDM based approach selected to optimize material erosion rate
- **Grinding tool material selection**
  - Both dressing approaches lend themselves to conductive, metal grinding tools
  - Softer, resin based tools more forgiving from an optical fabrication standpoint
  - Copper resin selected as electrically conductive, but mechanically elastic grind tool
- **EDM fluid selection**
  - Dionized water used as EDM fluid for Phase I demo work
- **Existing CCOS machine tool has been modified to accept in-situ EDM tool dressing components**
  - Output from a portable EDM unit modified with a stepdown transformer
  - CCOS grinding spindle modified to accept in-situ dressing components
    - Graphite and brass electrodes used for Phase I tests



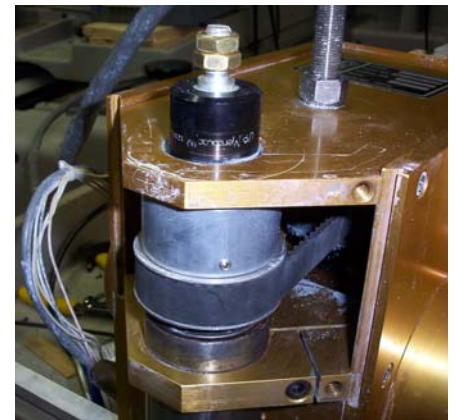
## Phase I Hardware Photos



Portable EDM Unit



Stepdown Transformer

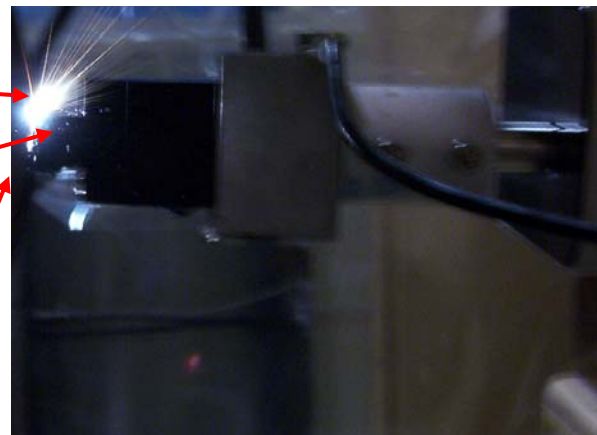


Modified CCOS Spindle

EDM discharge

Graphite Electrode

Grinding Tool



EDM dressing of  
copper/diamond  
grinding tool with  
graphite electrode



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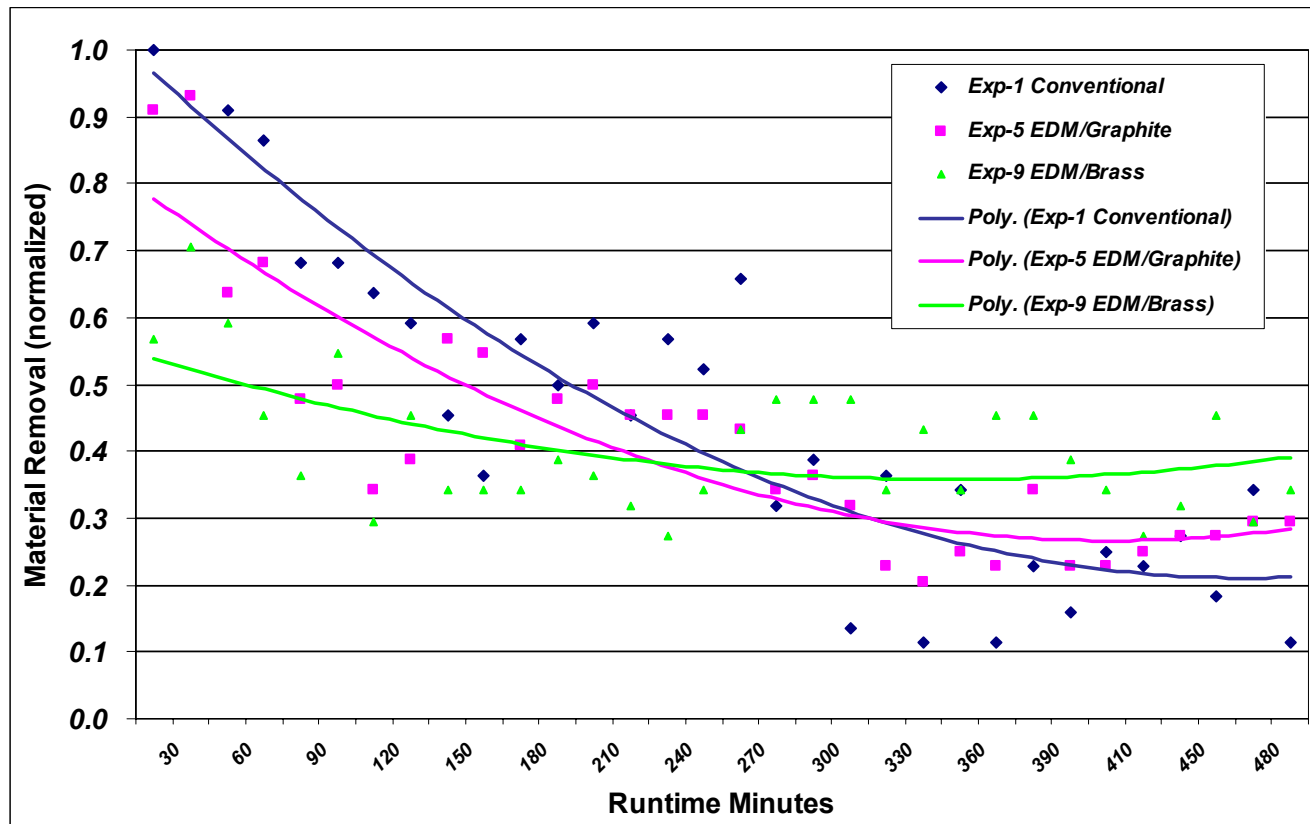
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## Phase I Demonstration Samples

- (6) 150 mm diameter I-70 Beryllium discs processed for experimentation
  - (2) conventionally CCOS ground
  - (2) EDM assisted (copper/diamond tool, graphite electrode)
  - (2) EDM assisted (copper/diamond tool, brass electrode)
- Processing done to look at material removal rate, and the uniformity of the material removal over time



# Phase I Results



- Both EDM experiments show an initial reduction in material removal rate compared with conventional CCOS grinding
  - Graphite ~20% reduction; Brass ~40% reduction
- Both electrodes show a more uniform material removal rate over time
  - Total material removal profile (averaged over the 500 min runtime shown) for EDM assisted grinding is ~11% less than conventional CCOS processed samples



# Phase I Summary – Phase II Program Plan

## ***Phase I Summary***

- Brass electrode EDM work shows some conflicting results
  - More uniform material removal profile could provide a dramatic improvement in CCOS grind/polish correlation and surface convergence
    - Particularly important for large aperture pieces such as JWST
  - Reduced material removal rate is problematic and not consistent with the positive results which have been experienced in the surface grinding of beryllium with assisted dressing techniques

## ***Phase II Plan***

- Examine additional process variations in order to build off of our Phase I results
  - Target improved material removal rate while improving the linearity of the material removal over time
  - New electrode materials, cutting materials, EDM fluids, application of micro-EDM, modify CCOS processing parameters, etc
- Apply these newly developed processes to manufacture a bare beryllium aspheric demo mirror
  - Compare processing time with conventional CCOS figured mirror